

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant	:	Bogart et al.
Appl. No.	:	10/692,953
Filed	:	October 24, 2003
For	:	PROCESS AND APPARATUS FOR BUBBLE REMOVAL DURING ELECTROCHEMICAL PROCESSING
Examiner	:	Wong, Edna
Group Art Unit	:	1753
Confirmation No.	:	1886

**RESPONSE TO RESTRICTION REQUIREMENT****Mail Stop Amendment**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

In an action mailed January 19, 2007, the Examiner required restriction of prosecution to one of the following groups of claims:

- I. Claims 1-15, drawn to a method for removing gas bubbles from a workpiece surface which is placed in a process solution for an electrochemical process, classified in class 205, subclass 80 or class 204, subclass 640.
- II. Claims 16-26, drawn to a system for removing gas bubbles from a surface of a workpiece which is placed in a process solution for an electrochemical process, classified in class 204, subclass 242.

In response, Applicants elect, without traverse, to proceed with examination on the merits of Group I (Claims 1-15), drawn to a method for removing gas bubbles from a workpiece surface which is place in a process solution for an electrochemical process, classified in class 205, subclass 8 or class 204, subclass 640.

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**A Listing of the Claims** begins on page 3 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.